DATA SHEET

SKY73009: 400 – 3000 MHz Direct Quadrature Demodulator

Applications

- PCS, DCS, GSM/GPRS, and EDGE receivers
- Third Generation (3G) wireless communications
- Power amplifier feedback/linearization
- Wireless Local Loops (WLLs)
- Wireless Local Area Networks (WLANs)

Features

- High IIP2 and IIP3
- Wideband RF input frequency range (400 to 3000 MHz)
- Wideband LO input frequency range (400 to 3000 MHz)
- Integrated LO balun
- Integrated LO amplifier
- On-chip I/Q phase splitter
- Differential IF output supports direct interface to A/D circuitry
- AM demodulation immunity
- Single +3.0 V supply
- RFLGA™ (32 pin, 5 x 5 mm) Pb-free package (MSL3, 260 °C per JEDEC J-STD-020)

Description

Skyworks SKY73009 is an integrated, broadband, high-dynamic range quadrature demodulator for use in various wireless communication system applications. The SKY73009 can perform quadrature demodulation of RF input signals from 400 to 3000 MHz directly to baseband frequencies. The quadrature outputs are differential and can be directly connected to most commonly available A/D converters.

The high dynamic range and second order Input Intercept Point (IIP2) value of the SKY73009 make it ideal for use in direct conversion and low Intermediate Frequency (IF) receivers.

Figure 1 shows a functional block diagram for the SKY73009. The device package and pinout for the 32-pin RF Land Grid Array (RFLGA) are shown in Figure 2.

NEW Skyworks offers lead (Pb)-free "environmentally friendly" packaging that is RoHS compliant (European Parliament for the Restriction of Hazardous Substances).

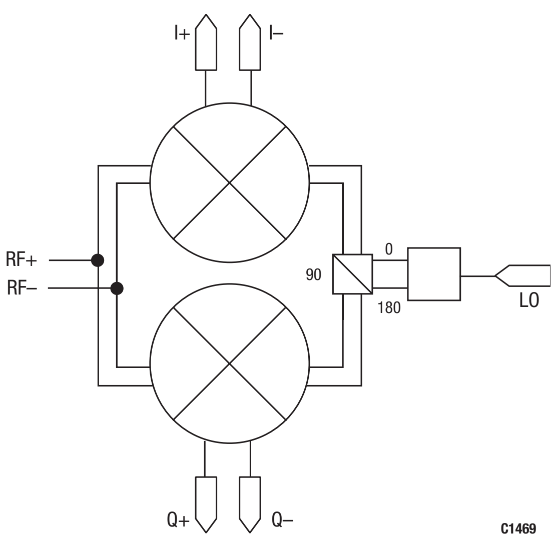

Figure 1. SKY73009 Functional Block Diagram

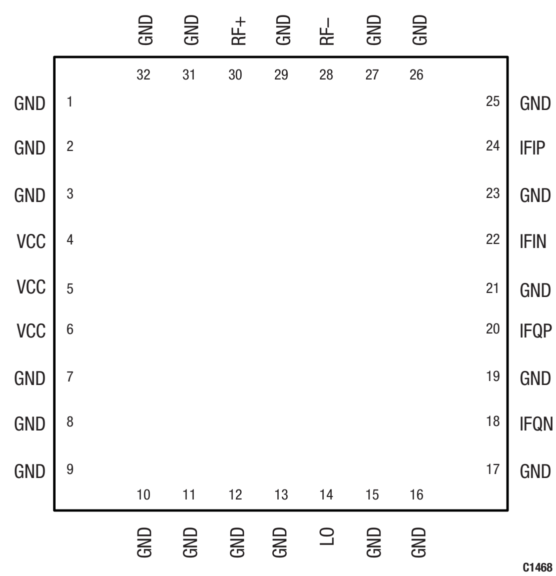

Figure 2. SKY73009 Pinout– 32-Pin RFLGA Package (Top View)

Table 1. SKY73009 Signal Descriptions

Pin #	Name	Description	Pin #	Name	Description
1	GND	Ground	17	GND	Ground
2	GND	Ground	18	IFQN	Negative quadrature IF output
3	GND	Ground	19	GND	Ground
4	VCC	+3 VDC supply	20	IFQP	Positive quadrature IF output
5	VCC	+3 VDC supply	21	GND	Ground
6	VCC	+3 VDC supply	22	IFIN	Negative in-phase IF output
7	GND	Ground	23	GND	Ground
8	GND	Ground	24	IFIP	Positive in-phase IF output
9	GND	Ground	25	GND	Ground
10	GND	Ground	26	GND	Ground
11	GND	Ground	27	GND	Ground
12	GND	Ground	28	RF–	Negative RF input
13	GND	Ground	29	GND	Ground
14	LO	LO input	30	RF+	Positive RF input
15	GND	Ground	31	GND	Ground
16	GND	Ground	32	GND	Ground

Table 2. SKY73009 Absolute Maximum Ratings
(T_A = +25 °C, unless otherwise noted)

Parameter	Symbol	Min	Typical	Max	Units
+3 V supply voltage	VCC	2.7		3.6	V
Power dissipation	P_D		210	320	mW
RF input power	P_{RFIN}			18	dBm
LO input power	P_{LOIN}		0	6	dBm
Operating case temperature	T_{OPR}	–40		+85	°C
Storage case temperature	T_{STG}	–40	0	+125	°C

Note: Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal values.

Electrical and Mechanical Specifications

Signal pin assignments and functional pin descriptions are provided in Table 1. The absolute maximum ratings of the SKY73009 are provided in Table 2 and the recommended operating conditions provided in Table 3. Electrical characteristics of the SKY73009 are provided in Table 4.

The typical performance of the SKY73009 with respect to frequency is illustrated in Figures 3 through 52. Figure 56 provides the package dimensions for the 32-pin RFLGA, and Figure 57 provides the tape and reel dimensions.

Package and Handling Information

Since the device package is sensitive to moisture absorption, it is baked and vacuum packed before shipping. Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The SKY73009 is rated to Moisture Sensitivity Level 3 (MSL3) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *PCB Design & SMT Assembly/Rework Guidelines for RFLGA Packages*, document number 103147.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format. For packaging details, refer to the Skyworks Application Note *Tape and Reel*, document number 101568.

Electrostatic Discharge (ESD) Sensitivity

The SKY73009 is a static-sensitive electronic device. Do not operate or store near strong electrostatic fields. Take proper ESD precautions.

Table 3. SKY73009 Recommended Operating Conditions

Parameter	Symbol	Min	Typical	Max	Units
+3 V supply voltage	VCC	2.7	3.0	3.3	V
Current consumption	I_{CC}		75		mA
Operating case temperature	T_{OPR}	–40		+85	°C

Table 4. SKY73009 Electrical Characteristics
(VCC = 3 V, IF = 10 MHz, LO Input Power = 0 dBm, T_C = 25 °C, unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typical	Max	Units
RF input frequency range			400		3000	MHz
LO input frequency range (Note 1)			400		3000	MHz
IF frequency range			DC		100	MHz
I/Q amplitude imbalance			–0.3		+0.3	dB
I/Q phase error				1		deg
IF output impedance (Note 2)				500		Ω
LO to RF isolation				50		dB
IF output DC level		Over process and operating temperature	1.64	1.75	1.92	V
RF Input (900 MHz)						
Voltage conversion gain			0	2		dB
SSB Noise Figure				14	16	dB
IIP2				60		dBm
IIP3			24	27		dBm
–1 dB compression point			10	12		dBm
RF input impedance				1.5:1	2.0:1	VSWR
LO input impedance				1.5:1	2.0:1	VSWR
RF Input (1900 MHz)						
Voltage conversion gain			–0.7	+1.3		dB
SSB Noise Figure				15	17	dB
IIP2				60		dBm
IIP3			22	25		dBm
–1 dB compression point			11	13		dBm
RF input impedance				1.5:1	2.0:1	VSWR
LO input impedance				1.5:1	2.0:1	VSWR

Note 1: For operation at LO frequencies <550 MHz and >2500 MHz, an LO power of +3 dBm must be used.

Note 2: Differential IFI and IFQ output impedance without the use of a 9:1 impedance ratio balun.

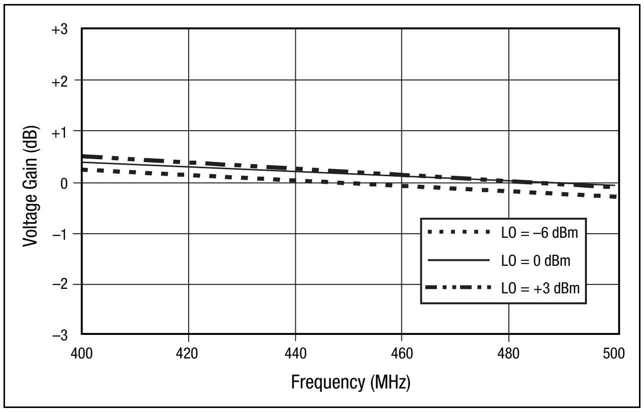

Figure 3. Voltage Conversion Gain vs Frequency: 400-500 MHz (Mini-Circuits TC1-1 Balun on RF Port)

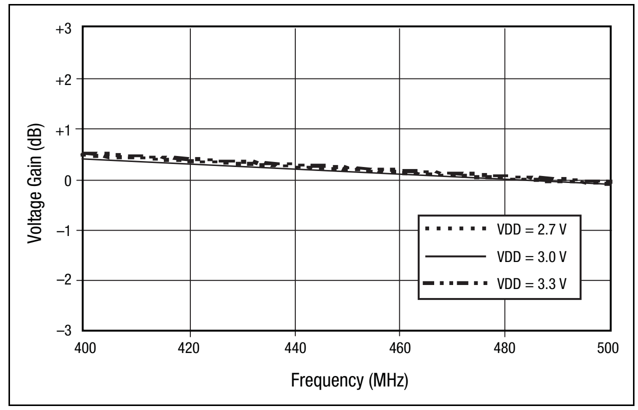

Figure 4. Voltage Conversion Gain vs Frequency: 400-500 MHz (Mini-Circuits TC1-1 Balun on RF Port)

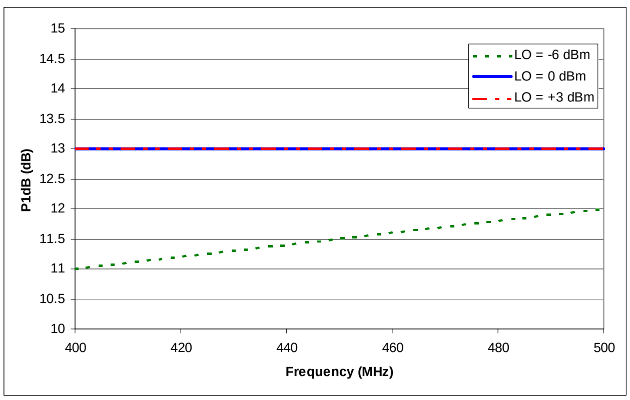

Figure 5. 1 dB Compression Point vs Frequency: 400-500 MHz (Mini-Circuits TC1-1 Balun on RF Port)

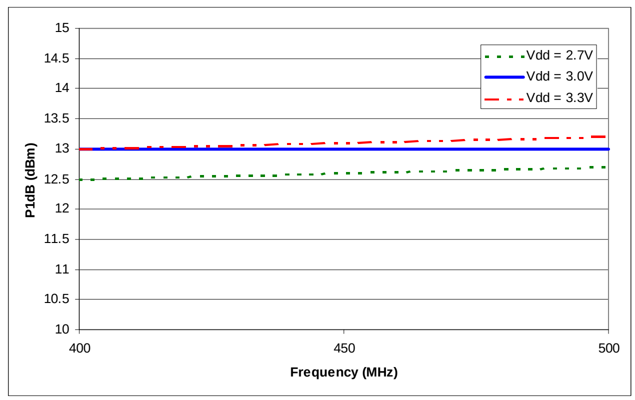

Figure 6. 1dB Compression Point vs Frequency: 400-500 MHz (Mini-Circuits TC1-1 Balun on RF Port)

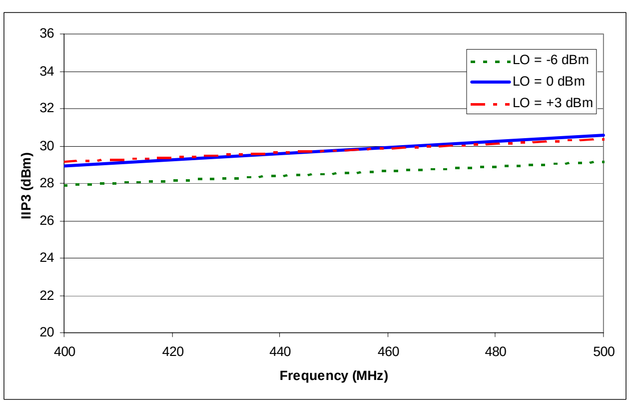

Figure 7. IIP3 vs Frequency: 400-500 MHz (Mini-Circuits TC1-1 Balun on RF Port)

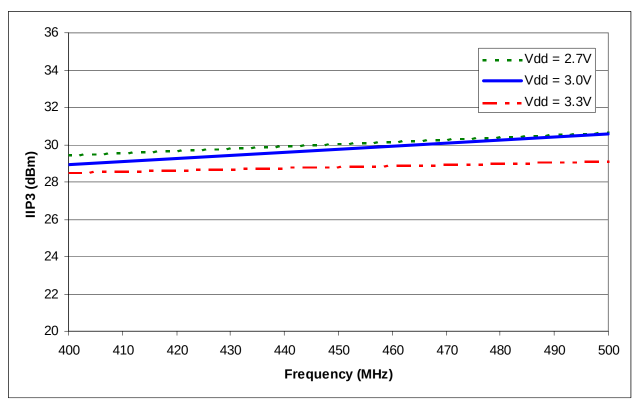

Figure 8. IIP3 vs Frequency: 400-500 MHz (Mini-Circuits TC1-1 Balun on RF Port)

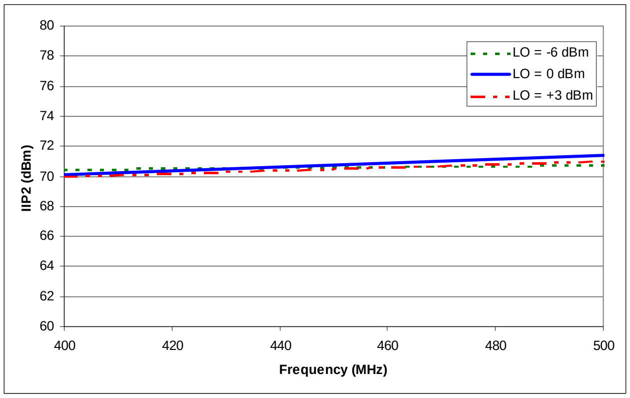

Figure 9. IIP2 vs Frequency: 400-500 MHz (Mini-Circuits TC1-1 Balun on RF Port)

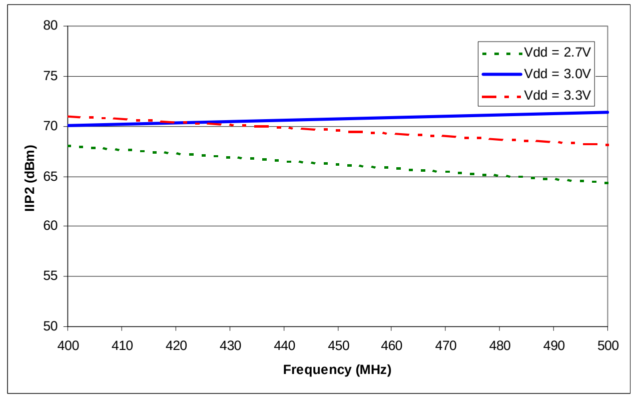

Figure 10. IIP2 vs Frequency: 400-500 MHz (Mini-Circuits TC1-1 Balun on RF Port)

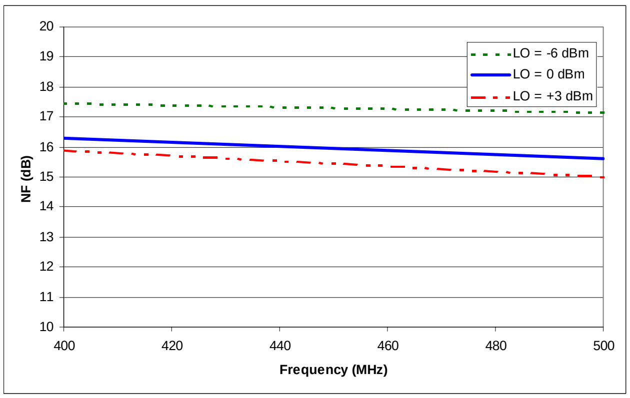

Figure 11. NF vs Frequency: 400-500 MHz (Mini-Circuits TC1-1 Balun on RF Port)

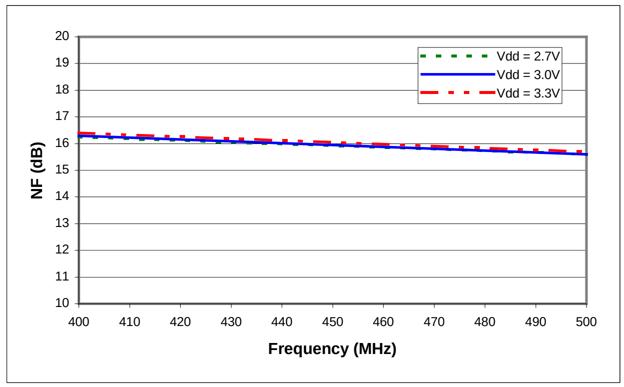

Figure 12. NF vs Frequency: 400-500 MHz (Mini-Circuits TC1-1 Balun on RF Port)

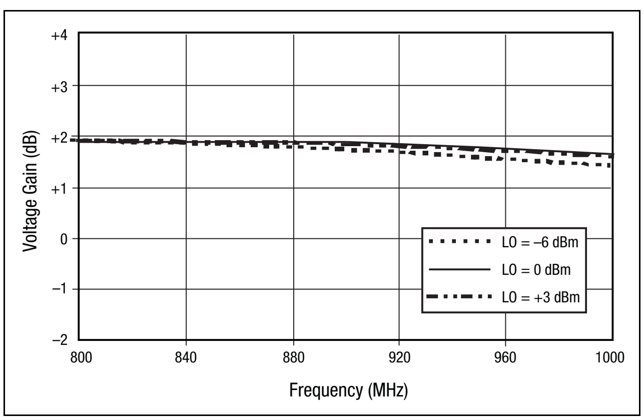

Figure 13. Voltage Conversion Gain vs Frequency: 800-1000 MHz (Murata LDB15C500A0900 Balun on RF Port)

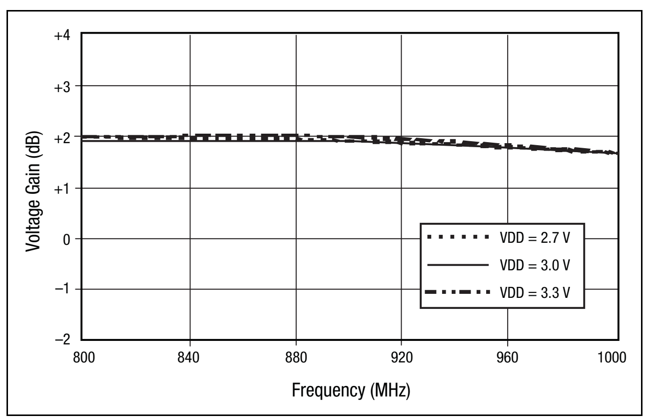

Figure 14. Voltage Conversion Gain vs Frequency: 800-1000 MHz (Murata LDB15C500A0900 Balun on RF Port)

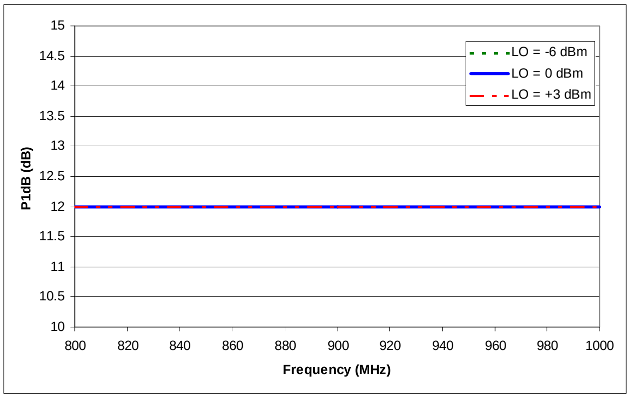

Figure 15. 1 dB Compression Point vs Frequency: 800-1000 MHz (Murata LDB15C500A0900 Balun on RF Port)

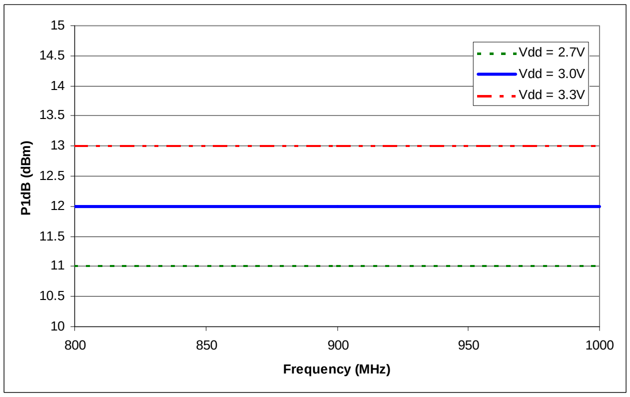

Figure 16. 1 dB Compression Point vs Frequency: 800-1000 MHz (Murata LDB15C500A0900 Balun on RF Port)

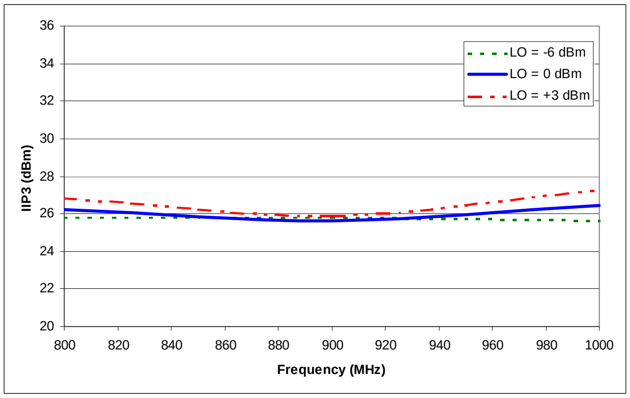

Figure 17. IIP3 vs Frequency: 800-1000 MHz (Murata LDB15C500A0900 Balun on RF Port)

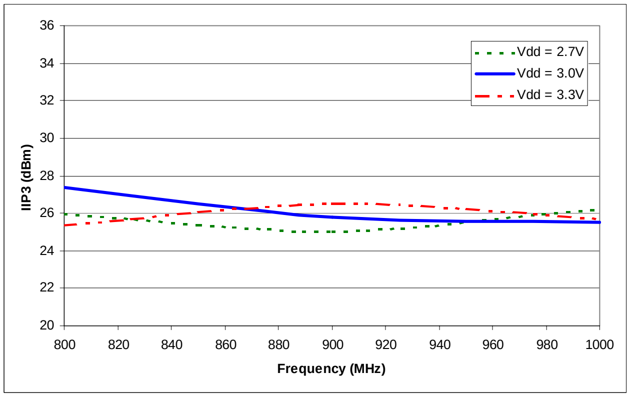

Figure 18. IIP3 vs Frequency: 800-1000 MHz (Murata LDB15C500A0900 Balun on RF Port)

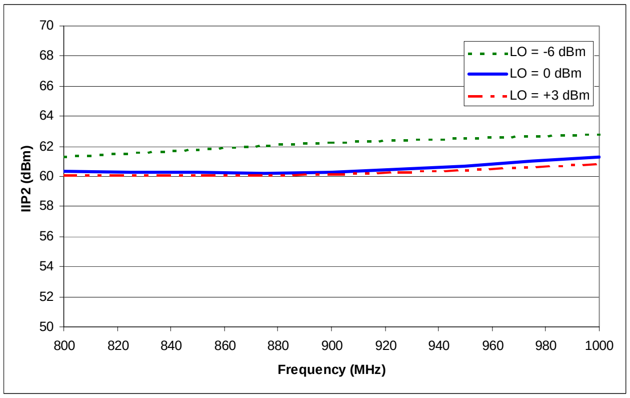

Figure 19. IIP2 vs Frequency: 800-1000 MHz (Murata LDB15C500A0900 Balun on RF Port)

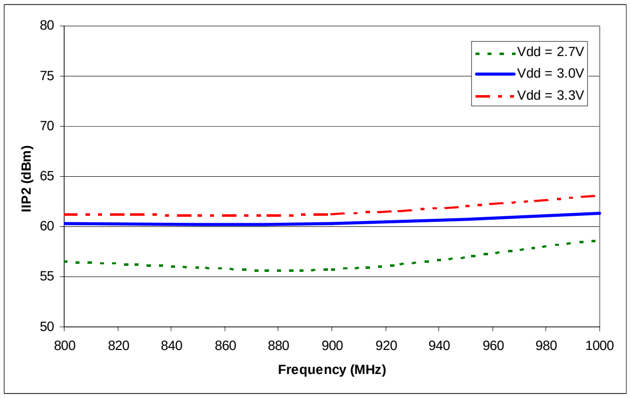

Figure 20. IIP2 vs Frequency: 800-1000 MHz (Murata LDB15C500A0900 Balun on RF Port)

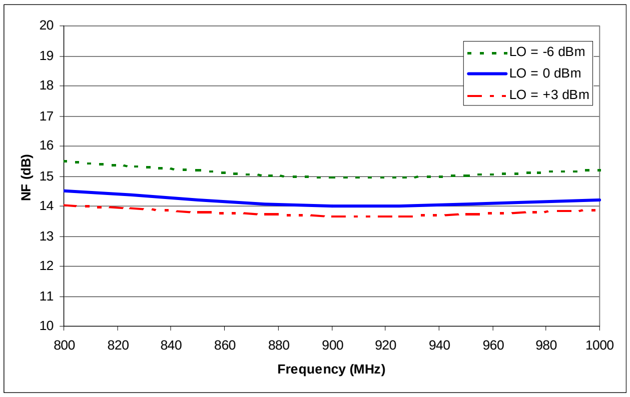

Figure 21. NF vs Frequency: 800-1000 MHz (Murata LDB15C500A0900 Balun on RF Port)

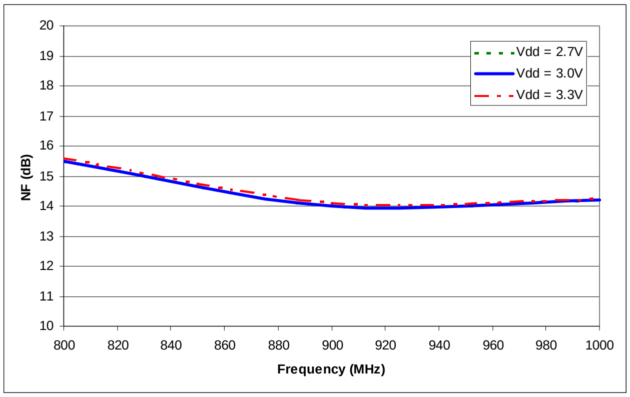

Figure 22. NF vs Frequency: 800-1000 MHz (Murata LDB15C500A0900 Balun on RF Port)

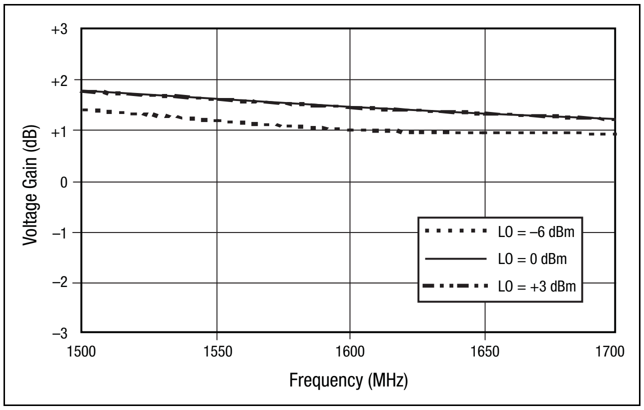

Figure 23. Voltage Conversion Gain vs Frequency: 1500-1700 MHz (Murata LDB15C500A1600 Balun on RF Port)

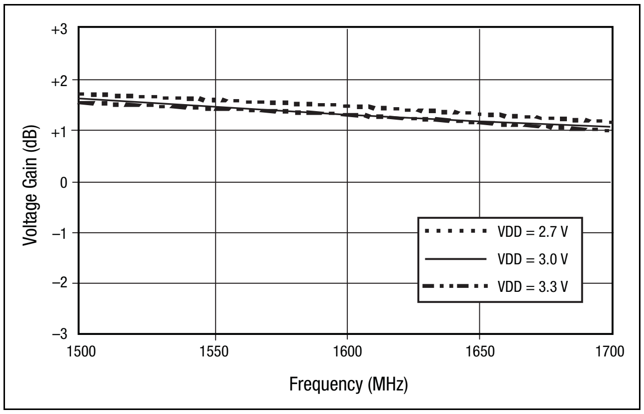

Figure 24. Voltage Conversion Gain vs Frequency: 1500-1700 MHz (Murata LDB15C500A1600 Balun on RF Port)

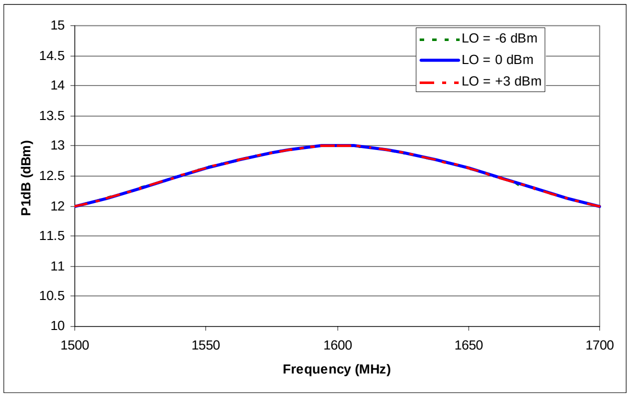

Figure 25. 1 dB Compression Point vs Frequency: 1500-1700 MHz (Murata LDB15C500A1600 Balun on RF Port)

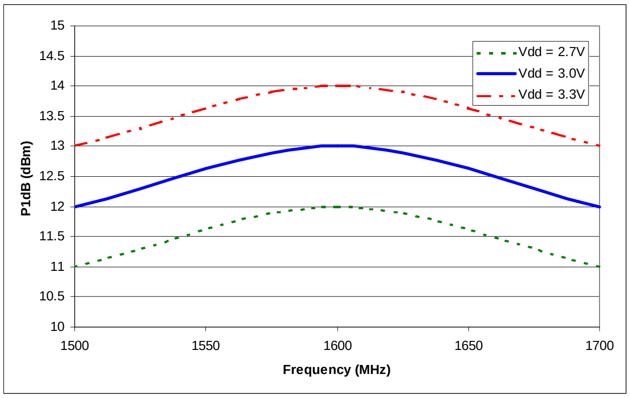

Figure 26. 1 dB Compression Point vs Frequency: 1500-1700 MHz (Murata LDB15C500A1600 Balun on RF Port)

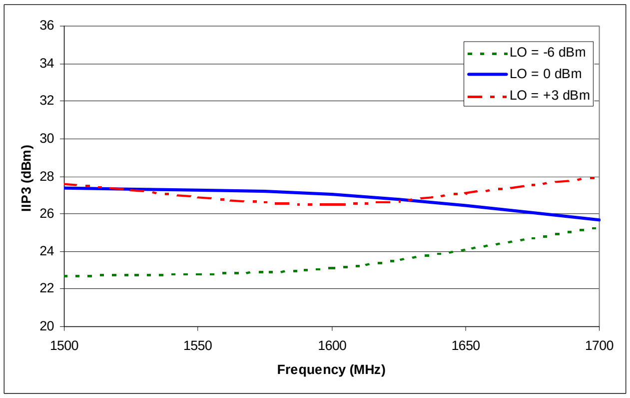

Figure 27. IIP3 vs Frequency: 1500-1700 MHz (Murata LDB15C500A1600 Balun on RF Port)

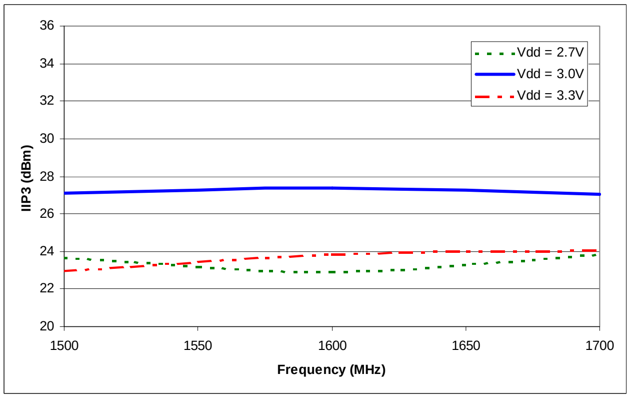

Figure 28. IIP3 vs Frequency: 1500-1700 MHz (Murata LDB15C500A1600 Balun on RF Port)

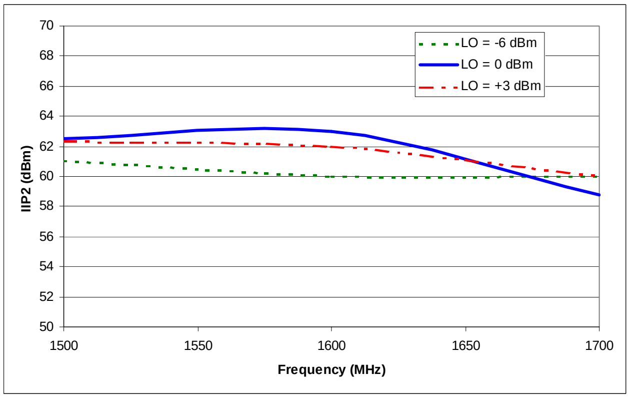

Figure 29. IIP2 vs Frequency: 1500-1700 MHz (Murata LDB15C500A1600 Balun on RF Port)

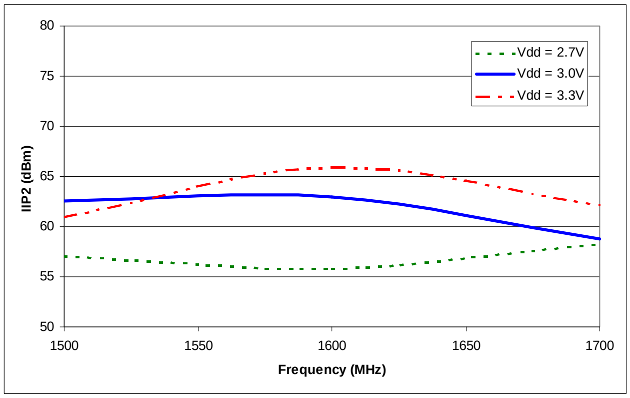

Figure 30. IIP2 vs Frequency: 1500-1700 MHz (Murata LDB15C500A1600 Balun on RF Port)

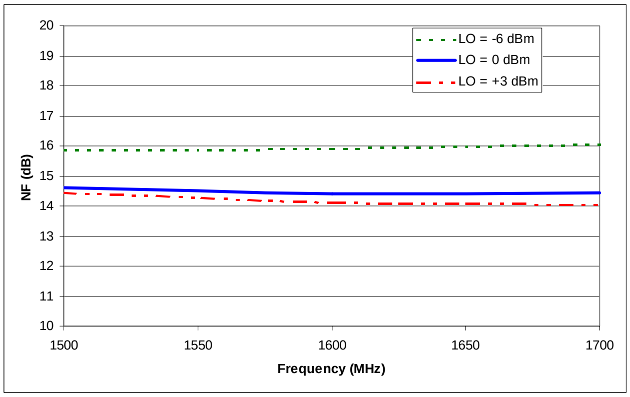

Figure 31. NF vs Frequency: 1500-1700 MHz (Murata LDB15C500A1600 Balun on RF Port)

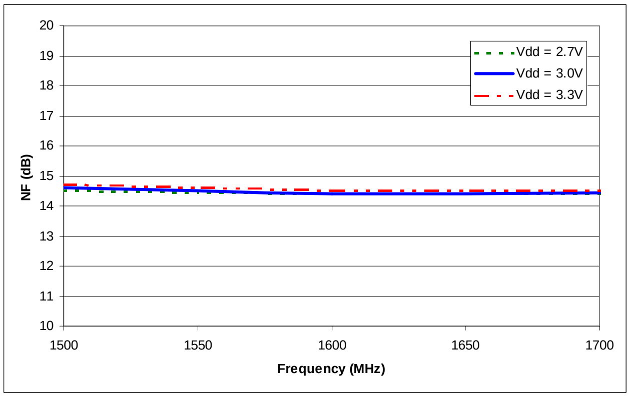

Figure 32. NF vs Frequency: 1500-1700 MHz (Murata LDB15C500A1600 Balun on RF Port)

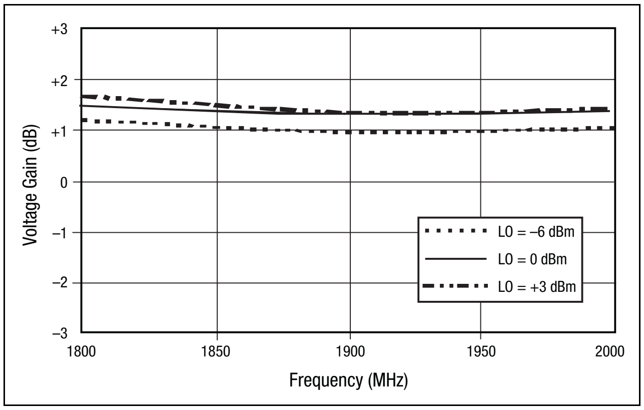

Figure 33. Voltage Conversion Gain vs Frequency: 1800-2000 MHz (Murata LDB15C500A1900 Balun on RF Port)

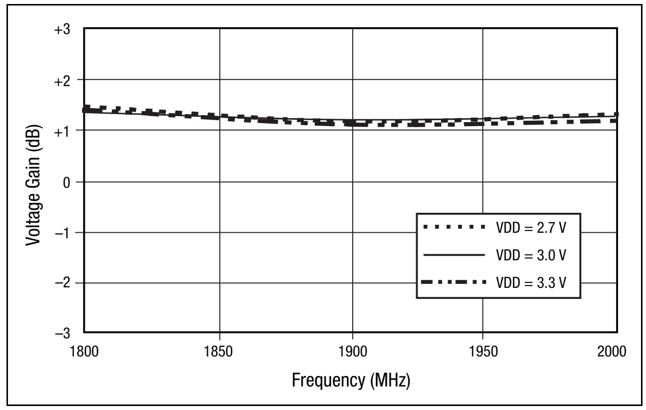

Figure 34. Voltage Conversion Gain vs Frequency: 1800-2000 MHz (Murata LDB15C500A1900 Balun on RF Port)

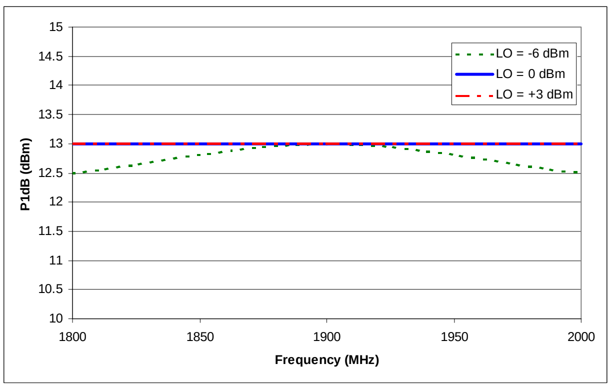

Figure 35. 1 dB Compression Point vs Frequency: 1800-2000 MHz (Murata LDB15C500A1900 Balun on RF Port)

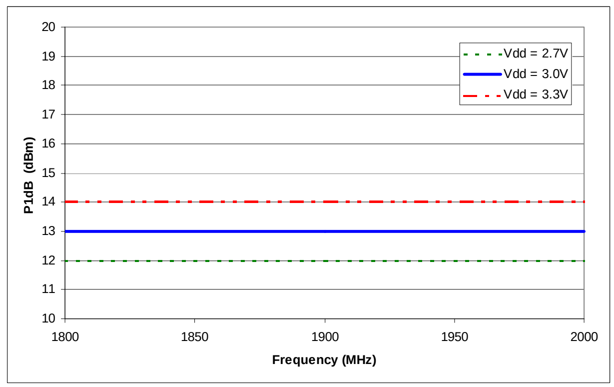

Figure 36. 1 dB Compression Point vs Frequency: 1800-2000 MHz (Murata LDB15C500A1900 Balun on RF Port)

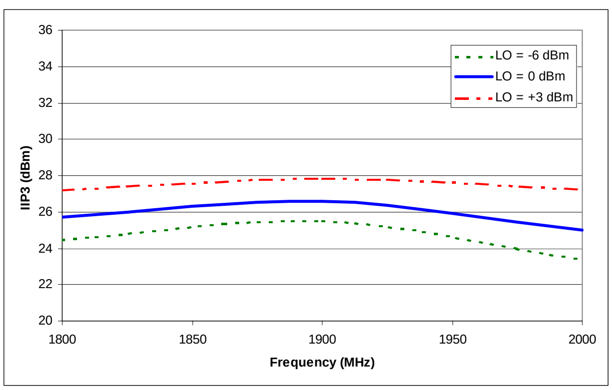

Figure 37. IIP3 vs Frequency: 1800-2000 MHz (Murata LDB15C500A1900 Balun on RF Port)

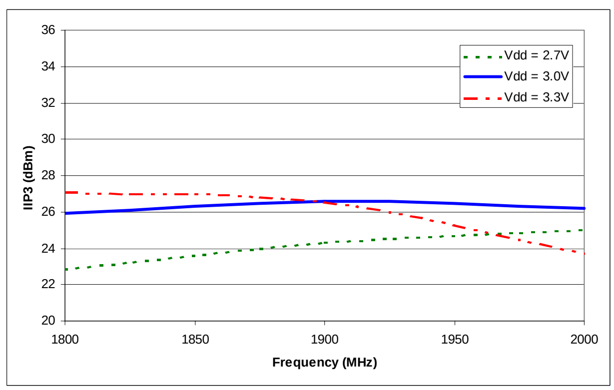

Figure 38. IIP3 vs Frequency: 1800-2000 MHz (Murata LDB15C500A1900 Balun on RF Port)

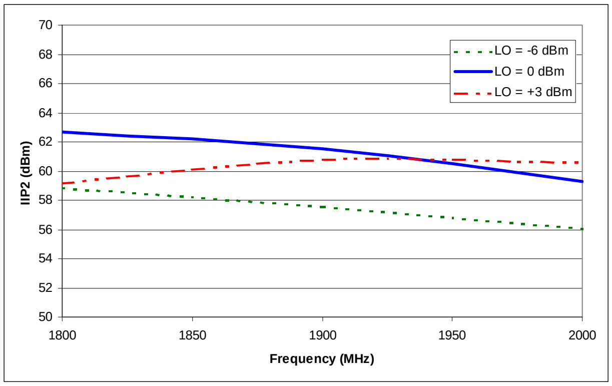

Figure 39. IIP2 vs Frequency: 1800-2000 MHz (Murata LDB15C500A1900 Balun on RF Port)

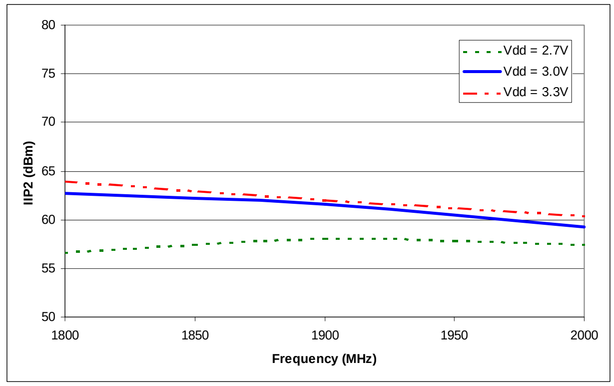

Figure 40. IIP2 vs Frequency: 1800-2000 MHz (Murata LDB15C500A1900 Balun on RF Port)

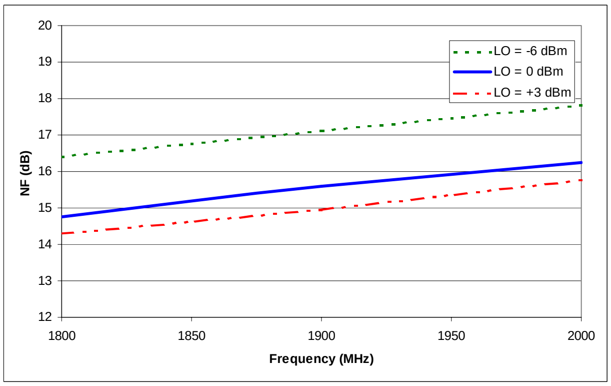

Figure 41. NF vs Frequency: 1800-2000 MHz (Murata LDB15C500A1900 Balun on RF Port)

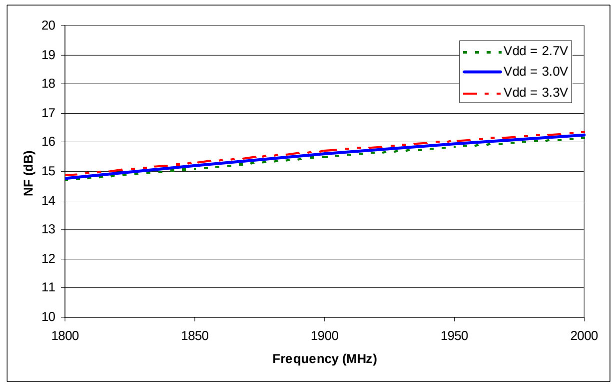

Figure 42. NF vs Frequency: 1800-2000 MHz (Murata LDB15C500A1900 Balun on RF Port)

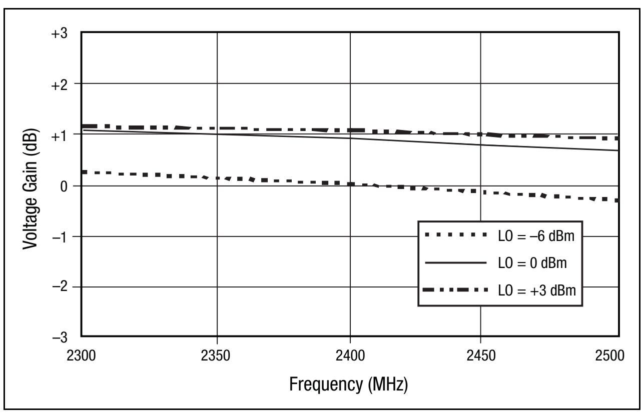

Figure 43. Voltage Conversion Gain vs Frequency: 2300-2500 MHz (Murata LDB15C500A2400 Balun on RF Port)

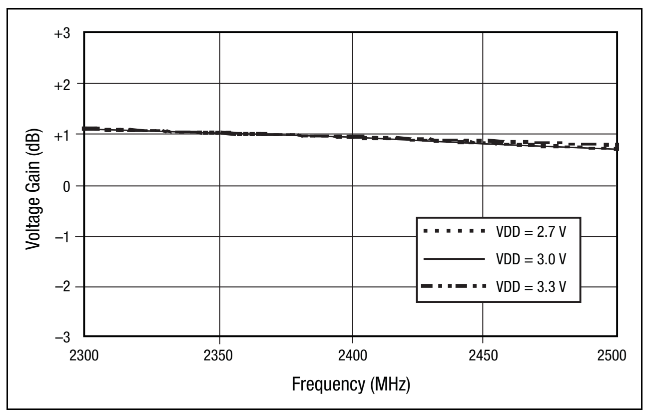

Figure 44. Voltage Conversion Gain vs Frequency: 2300-2500 MHz (Murata LDB15C500A2400 Balun on RF Port)

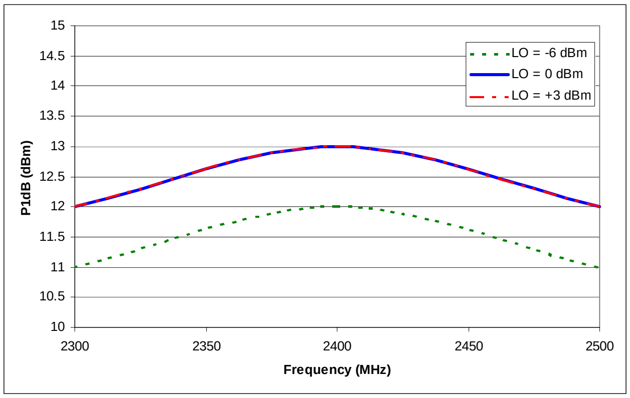

Figure 45. 1 dB Compression Point vs Frequency: 2300-2500 MHz (Murata LDB15C500A2400 Balun on RF Port)

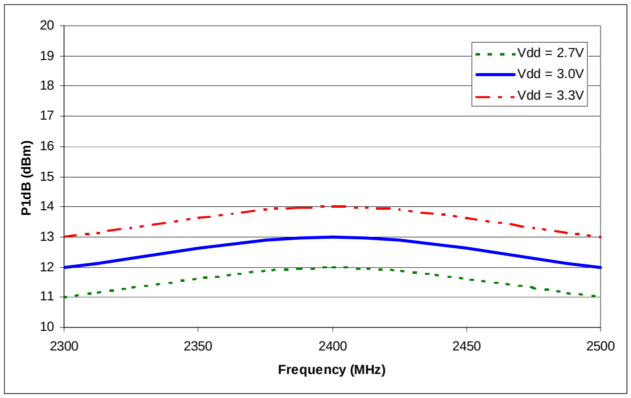

Figure 46. 1 dB Compression Point vs Frequency: 2300-2500 MHz (Murata LDB15C500A2400 Balun on RF Port)

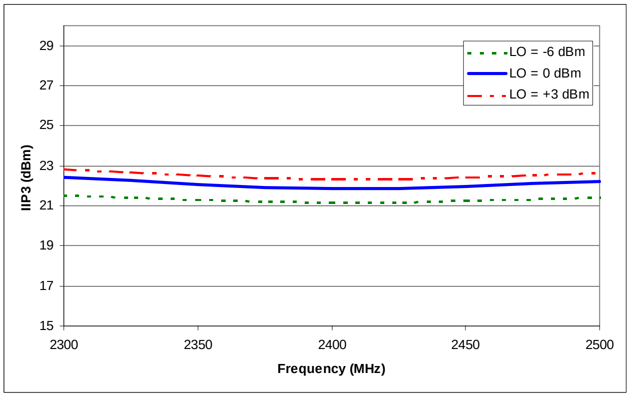

Figure 47. IIP3 vs Frequency: 2300-2500 MHz (Murata LDB15C500A2400 Balun on RF Port)

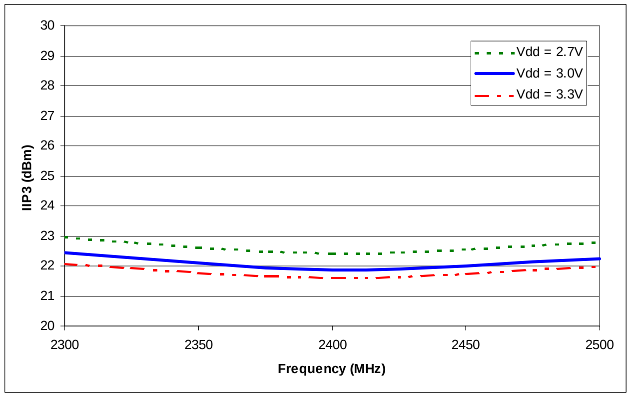

Figure 48. IIP3 vs Frequency: 2300-2500 MHz (Murata LDB15C500A2400 Balun on RF Port)

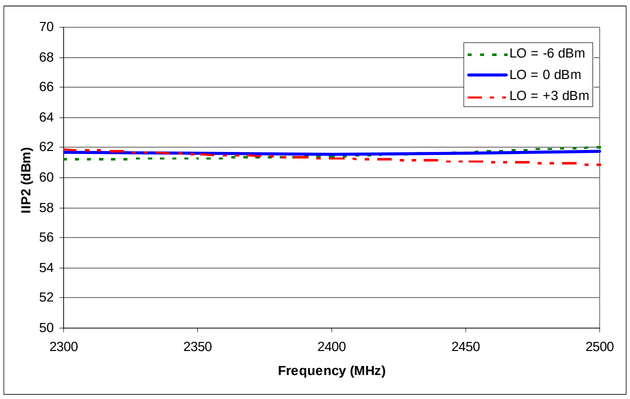

Figure 49. IIP2 vs Frequency: 2300-2500 MHz (Murata LDB15C500A2400 Balun on RF Port)

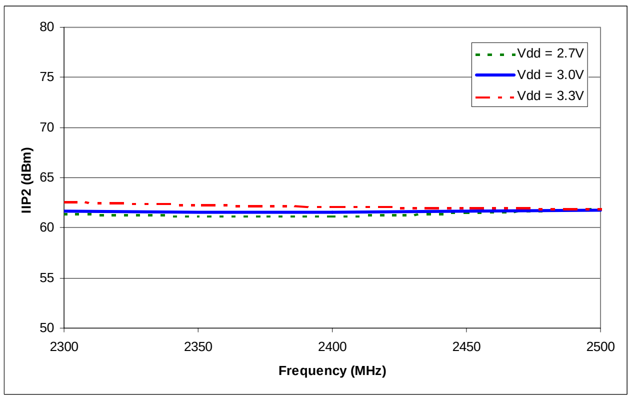

Figure 50. IIP2 vs Frequency: 2300-2500 MHz (Murata LDB15C500A2400 Balun on RF Port)

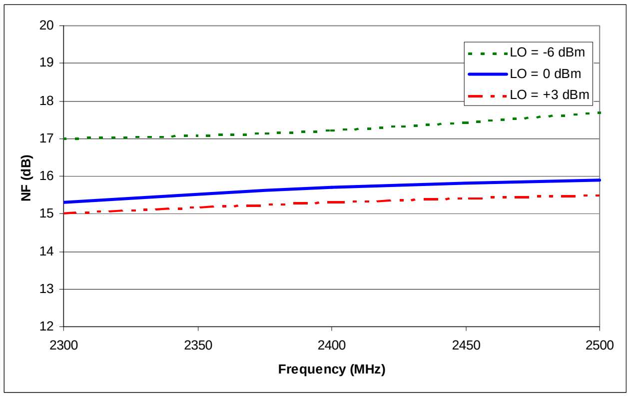

Figure 51. NF vs Frequency: 2300-2500 MHz (Murata LDB15C500A2400 Balun on RF Port)

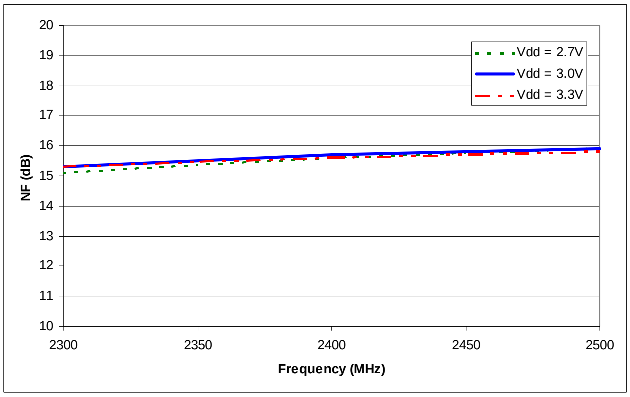

Figure 52. NF vs Frequency: 2300-2500 MHz (Murata LDB15C500A2400 Balun on RF Port)

Evaluation Board Description

The SKY73009 Evaluation Board is used to test the performance of the SKY73009 direct quadrature demodulator. An Evaluation Board schematic diagram is shown in Figure 53. The Evaluation Board assembly diagram is shown in Figure 54.

Circuit Design Considerations

The following design considerations are general in nature and must be followed regardless of final use or configuration.

1. Paths to ground should be made as short as possible.
2. The ground pad of the SKY73009 direct quadrature demodulator has special electrical and thermal grounding requirements. This pad is the main thermal conduit for heat dissipation. Since the circuit board acts as the heat sink, it must shunt as much heat as possible from the device. As such, design the connection to the ground pad to dissipate the maximum wattage produced to the circuit board.
3. Two external output bypass capacitors are required on the VCC pin. The values of these capacitors will change with respect to the desired RF frequency. One capacitor should be used for low frequency bypassing and the other capacitor for high frequency bypassing. Special attention should be given so that the smaller value capacitor does not go into self-resonance at the desired RF frequency.
4. The RF input must be driven differentially. A 1:1 impedance ratio balun is recommended with a center tap on the secondary side that is DC grounded.

Testing Procedure

Use the following procedure to set up the SKY73009 Evaluation Board for testing. Refer to Figure 55 for guidance:

1. Connect a +3.0 VDC power supply using an insulated supply cable. If available, enable the current limiting function of the power supply to 100 mA.
2. Connect a signal generator to the RF signal input port. Set it to the desired RF frequency at a power level of 0 dBm to the Evaluation Board but do NOT enable the RF signal.
3. Connect a signal generator to the LO signal input port. Set to the desired LO frequency at a power level of 0 dBm, but do not enable.
4. Connect a spectrum analyzer to the IFI signal output port and terminate the IFQ signal input port in 50 Ω.
5. Enable the power supply.
6. Enable the LO input signal.
7. Enable the RF signal.
8. Take measurements and repeat these steps for channel Q.

CAUTION: *If any of the input signals exceed the rated maximum values, the SKY73009 Evaluation Board can be permanently damaged.*

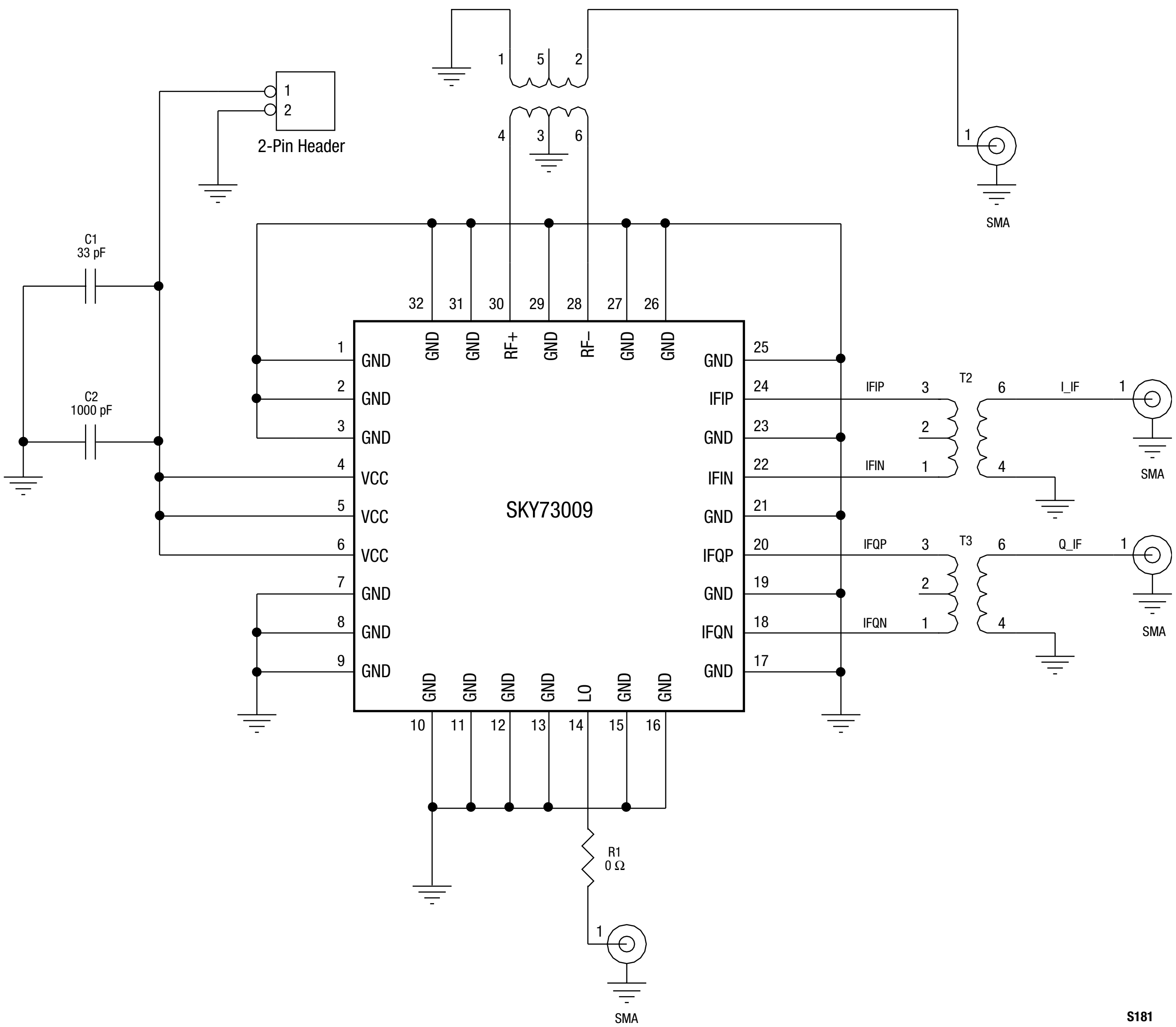

Figure 53. SKY73009 Evaluation Board Schematic

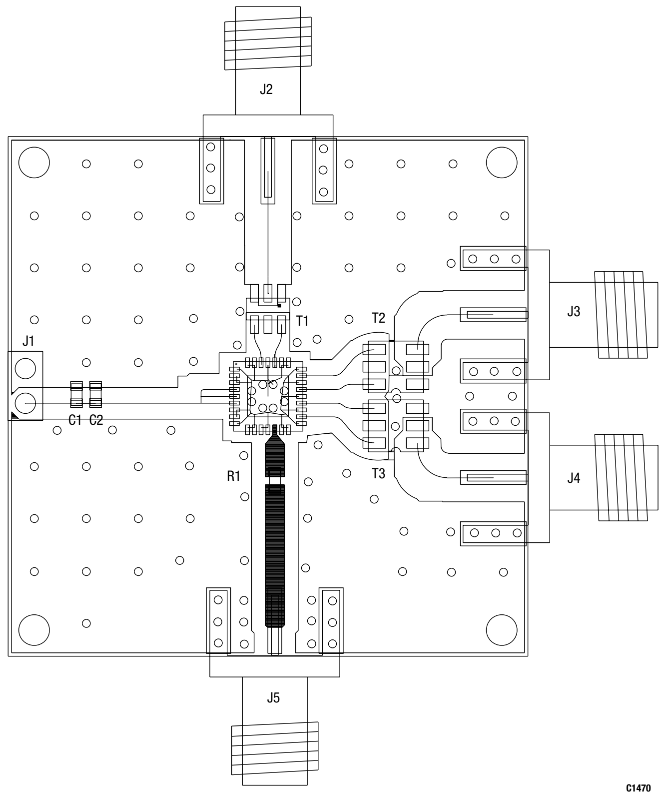

Figure 54. SKY73009 Evaluation Board Assembly Diagram (Top View)

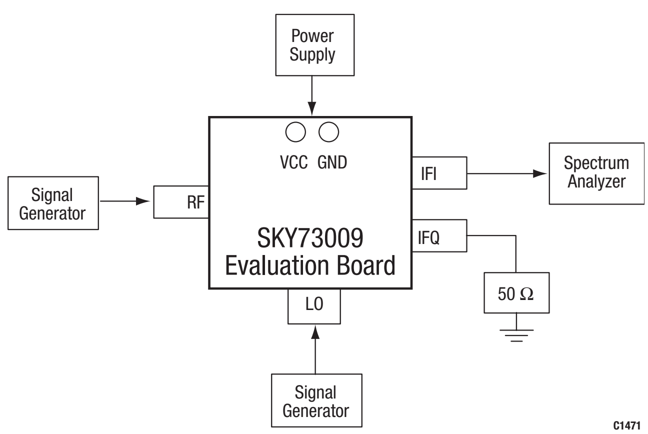

Figure 55. SKY73009 Evaluation Board Testing Configuration

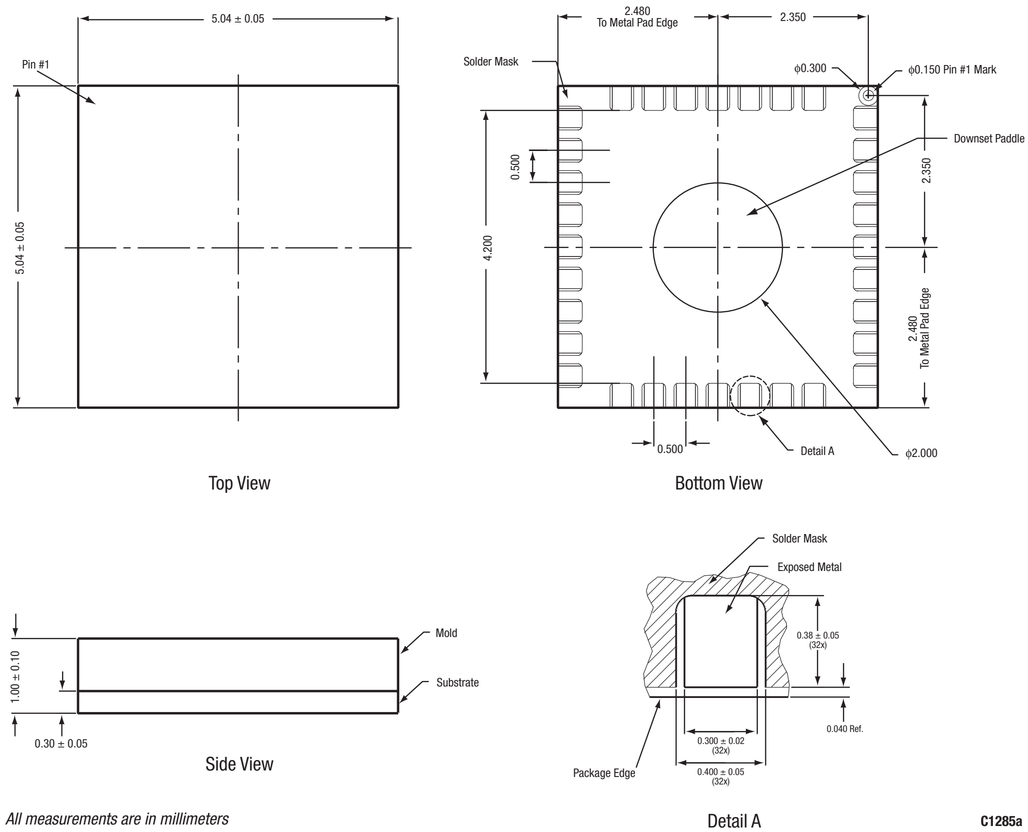

Figure 56. SKY73009 32-Pin RFLGA Package Dimensions

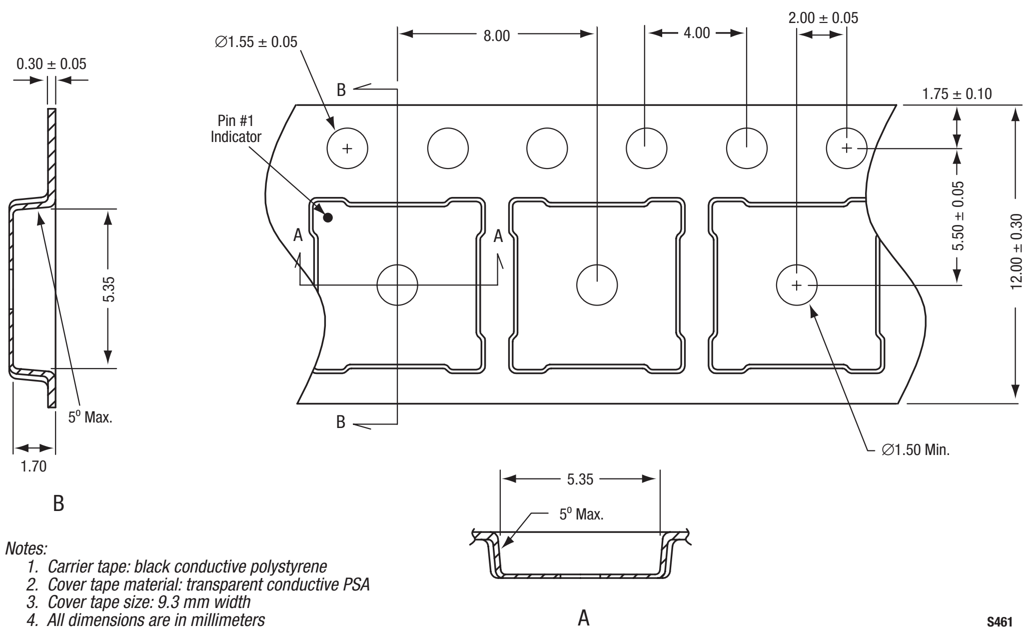

Figure 57. SKY73009 32-Pin RFLGA Tape and Reel Dimensions

Ordering Information

Model Name	Manufacturing Part Number	Evaluation Kit Part Number
SKY73009 400-3000 MHz Direct Quadrature Modulator	SKY73009-11	TW11-D982 (tuned for 800 to 1000 MHz) TW11-D992 (tuned for 1800 to 2000 MHz) TW12-D275 (custom frequency board)